UTC UNISONIC TECHNOLOGIES CO., LTD

UNA10R180H

42A, 100V N-CHANNEL POWER MOSFET

DESCRIPTION

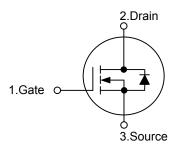
The UTC **UNA10R180H** is a N-Channel enhancement MOSFET, it uses UTC's advanced technology to provide customers with a minimum on-state resistance and high switching speed.

The UTC **UNA10R180H** is suitable for use in a wide variety of applications.

FEATURES

* $R_{DS(ON)}$ < 18 m Ω @ V_{GS}=10V, I_D=33A * High switching speed

SYMBOL

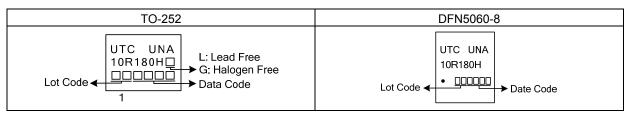


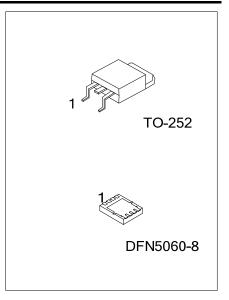
ORDERING INFORMATION

Ordering Number		Daakaga	Pin Assignment							Deaking	
Lead Free	Halogen Free	Package	1	2	3	4	5	6	7	8	Packing
UNA10R180HL-TN3-R	UNA10R180HG-TN3-R	TO-252	G	D	S	1	-	-	-	-	Tape Reel
NA10R180HL-K08-5060-R UNA10R180HG-K08-5060-R		DFN5060-8	S	S	S	G	D	D	D	D	Tape Reel
Note: Pin Assignment: G: Gate D: Drain S: Source											

UNA10R180HG-TN3-R T T (1)Packing Type	(1) R: Tape Reel				
(2)Package Type	(2) TN3: TO-252, K08-5060: DFN5060-8				
(3)Green Package	(3) G: Halogen Free and Lead Free, L: Lead Free				

■ MARKING





ABSOLUTE MAXIMUM RATINGS

PARAMETER			SYMBOL	RATINGS	UNIT	
Drain-Source Voltage			V _{DSS}	100	V	
Gate-Source Voltage			V _{GSS}	±20	V	
Drain Current		_	ᡚ 10V, T _C =25°C on Limited)		56	А
	Continuous	V _{GS} @10V, T _C =100°C		I _D	39	А
		V _{GS} @ 10V (Package Limited), T _C =25°C			42	A
	Pulsed (Note 2)			I _{DM}	220	Α
Single Pulse Avalanche Energy Tested Value (Note 6)			E _{AS} (Tested)	200	mJ	
Power Dissipation (T _c =25°C) TO-252 DFN5060-8		D	140	W		
		DFN5060-8	PD	39	W	
Junction Temperature			TJ	-55 ~ +175	°C	
Storage Temperature Range			T _{STG}	-55 ~ +175	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive rating; pulse width limited by maximum junction temperature.
- 3. L=0.28mH, I_{AS}=33A, V_{DD}= 10V, R_G=25 Ω , Starting T_J=25°C
- 4. I_{SD} \leq 33A, di/dt \leq 200A/µs, V_{DD} \leq BV_{DSS}, starting T_J=25°C
- 5. Limited by T_{Jmax} , see Test Circuits and Waveforms for typical repetitive avalanche performance.
- 6. This value determined from sample failure population. 100% tested to this value in production.

■ THERMAL CHARACTERISTICS

PARAMET	ĒR	SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-252	0	110	°C/W
	DFN5060-8	θ _{JA}	35	°C/W
lunation to Coop	TO-252	0	0.89	°C/W
Junction to Case	DFN5060-8	θ _{JC}	3.2	°C/W

Note: The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.



UNA10R180H

Power MOSFET

■ ELECTRICAL CHARACTERISTICS (TJ=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =250μA, V _{GS} =0V				V
Drain Course Lookage Current	1	V _{DS} =100V, V _{GS} =0V			20	μA
Drain-Source Leakage Current	I _{DSS}	V _{DS} =100V, V _{GS} =0V , T _J =125°C			250	μA
Cata Source Lookage Current		V _{GS} =20V			200	nA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =-20V			-200	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250µA	2.0		4.0	V
Static Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =33A (Note 2)		15	18	mΩ
DYNAMIC PARAMETERS						
Input Capacitance	CISS			2930		pF
Output Capacitance	C _{OSS}	V _{GS} =0V, V _{DS} =25V, f=1.0MHz		290		pF
Reverse Transfer Capacitance	C _{RSS}			180		pF
	C _{oss}	V _{GS} =0V, V _{DS} =1.0V, f=1.0MHz		1200		pF
Output Capacitance		V _{GS} =0V, V _{DS} =80V, f=1.0MHz		180		pF
SWITCHING PARAMETERS						
Total Gate Charge	Q _G			69	100	nC
Gate to Source Charge	Q _{GS}	−V _{GS} =10V, V _{DS} =30V, I _D =1A −I _G =100μA (Note 2)		15		nC
Gate-to-Drain ("Miller") Charge	Q_{GD}	$I_G = 100 \mu A (100 e 2)$		25		nC
Turn-ON Delay Time	t _{D(ON)}			14		ns
Rise Time	t _R	V _{DD} =30V, V _{GS} =10V, I _D =6A,		43		ns
Turn-OFF Delay Time	t _{D(OFF)}	R _G =6.8Ω (Note 2)		53		ns
Fall-Time	t _F			42		ns
SOURCE- DRAIN DIODE RATINGS AND	CHARACTER	RISTICS				
Continuous Source Current	1				56	Δ
(Body Diode)	I _S				00	A
Pulsed Source Current	1				220	٨
(Body Diode) (Note 1)	I _{SM}				220	A
Diode Forward Voltage	V _{SD}	T _J =25°C, I _S =33A, V _{GS} =0V (Note 2)			1.3	V
Reverse Recovery Time	trr	T _J =25°C, I _S =33A,		35	53	ns
Reverse Recovery Charge	Qrr	di/dt=100A/µs, V _{DD} =50V (Note 2)		41	62	nC

Notes: 1. Repetitive rating; pulse width limited by maximum junction temperature.

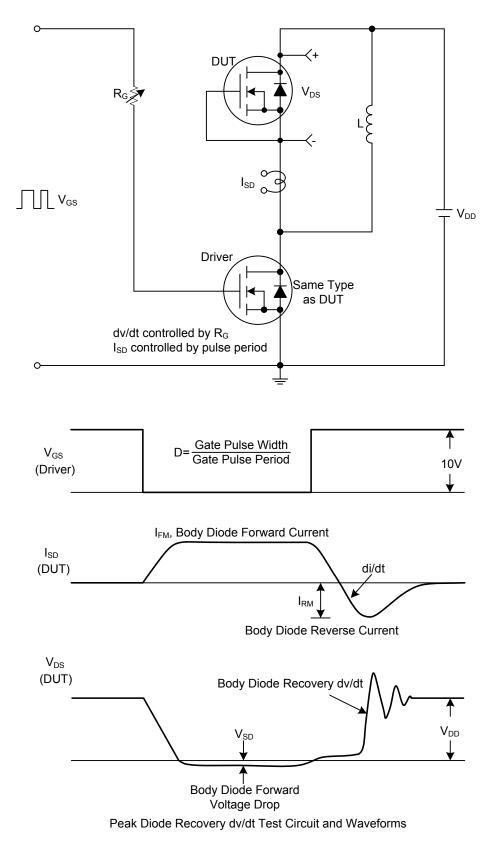
2. Pulse width \leq 1.0ms, duty cycle \leq 2%.

3. C_{OSS} eff. is a fixed capacitance that gives the same charging time as C_{OSS} while V_{DS} is rising from 0 to 80% $V_{DSS}.$



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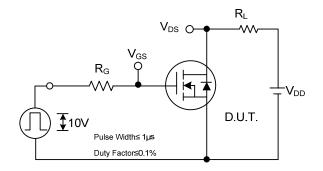
TEST CIRCUITS AND WAVEFORMS

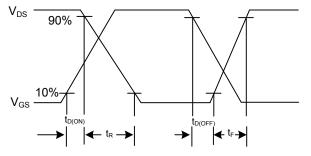




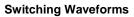
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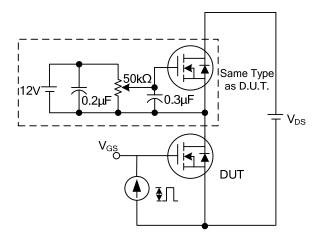
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



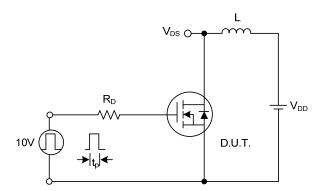


Switching Test Circuit

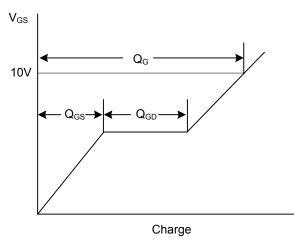




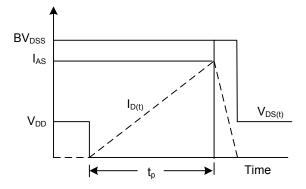
Gate Charge Test Circuit



Unclamped Inductive Switching Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Waveforms



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